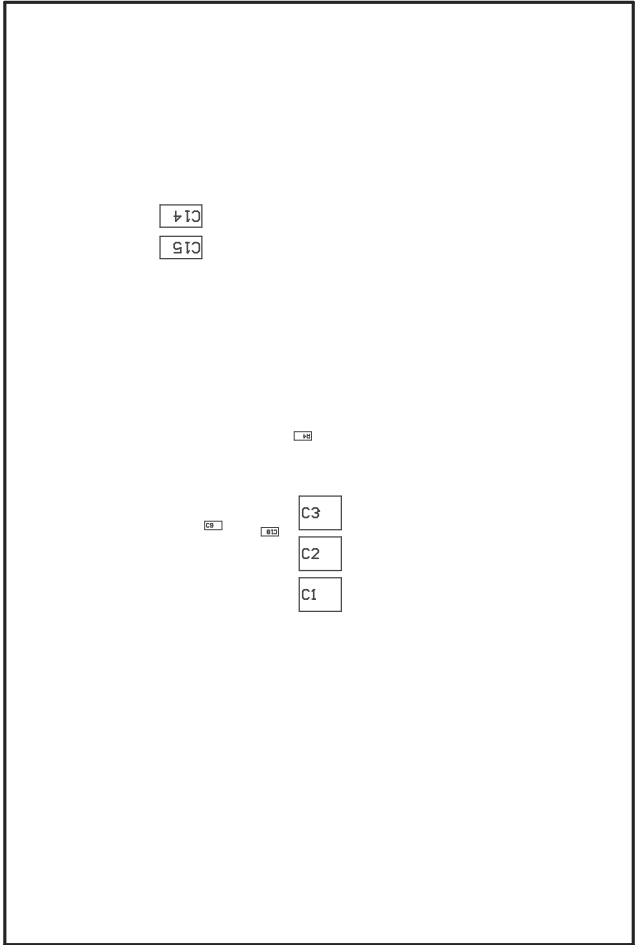


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE         | BOARD #: PMP10852                | REV: B            | SVN REV: Not In VersionControl |
|                                  |                                  |                   |                                |
| PLOT NAME = Top Assembly Drawing | GENERATED : 4/20/2015 3:50:36 PM | TEXAS INSTRUMENTS |                                |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

|                                     |                                  |        |                                |
|-------------------------------------|----------------------------------|--------|--------------------------------|
| PCB VIEWED FROM BOTTOM SIDE         | BOARD #: PMP10852                | REV: B | SVN REV: Not In VersionControl |
|                                     |                                  |        |                                |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 4/20/2015 3:50:37 PM |        | TEXAS INSTRUMENTS              |

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